Special Issue

Breaking Barriers: Microneedles in Therapeutics and Diagnostics

Message from the Guest Editors

This Special Issue welcomes contributions that highlight recent advances in microneedle design, fabrication, and application, with a focus on platforms that enable the precise, targeted, and painless delivery of small molecules, biologics, and vaccines. We welcome original research and reviews covering solid, coated, dissolving, and hollow microneedles and hybrid systems that integrate sensing, controlled release, or smart feedback features. In addition, this Special Issue aims to explore challenges in clinical translation, including regulatory hurdles, manufacturing scalability, and stability concerns. We particularly seek papers that cover topics such as transdermal delivery enhancements (e.g., heat, ultrasound), skin interface optimization, and diagnostic sampling using microneedles. By uniting themes of precision, innovation, and patient-centric design, this Special Issue aims to capture the current momentum in microneedle research and demonstrate how these tiny tools are breaking barriers in both therapeutic and diagnostic landscapes-transforming the future of personalized medicine, painless treatment, and on-skin technology.

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About the Journal

Message from the Editor-in-Chief

You are invited to contribute research articles or comprehensive reviews for consideration and publication in *Micromachines* (ISSN 2072-666X). *Micromachines* is published in the open access format. Research articles, reviews and other contents are released on the internet immediately after acceptance. The scientific community and the general public have unlimited free access to the content as soon as it is published. As an open access journal, *Micromachines* is supported by the authors or their institutes by payment of article processing charges (APC) for accepted papers. We are pleased to welcome you as our authors.

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